YOR920080679US1

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🖾 Assignment 🔲 Merger	City: Armonk State: NY ZIP Code: 10504
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Execution Date(s): June 26, 2009	Additional name(s) & address(es) attached? 🔲 Yes 🗵 No
4. Application number(s) or patent number(s): This document is being filed together with a new application.	
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N T DOM: 70.	7. Total fee (37 CFR 3.41):\$40.00
Name: Harry F. Smith, Esq.	☐ Enclosed
Address: Harrington & Smith, PC	☐ Enclosed ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐
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	Page 1 of 3.

PATENT REEL: 022896 FRAME: 0313 IBM DOCKET NUMBER: YOR920080679US1

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention: HEAT SINK ASSEMBLY

and further identified by the IBM Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:	
Serial Number:	(insert series code and serial number here if/when available)
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[Inventor Signature Pages Follow] Page 1 of 2

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Executed by Inventor 1 of 1

Mark Delognan Schultz

Date: 06/26/09

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